

WHAT IS CLAIMED IS:

1. A plating method comprising putting an object product to be plated in each accommodating concave portion in a carrier tape having a number of spaced accommodating concave portions and passing the object product to be plated through a plating apparatus by feeding the carrier tape so as to form metallic plating layer on the surface of the object product to be plated.
2. The plating method according to claim 1 wherein washing units are disposed in the upstream and downstream of said plating unit and said object product to be plated is passed through each washing unit and washed.
3. A plating apparatus comprising a feeding mechanism for the carrier tape containing a number of accommodating concave portions each capable of keeping an object product to be plated and a cell so constructed that the carrier tape can pass through plating solution and the cell is provided with a cathode member for supplying the object product to be plated with electricity.
4. The plating apparatus according to claim 3 wherein each accommodating concave portion in said carrier tape includes an opening which allows plating solution to flow in and out and said cathode member to invade.